

BOARD CHARACTERISTICS

Copper Layer Count:	4	Board Thickness:	62.99 mils
Board overall dimensions:	1781.50 mils x 2356.30 mils		
Min track/spacing:	6.00 mils / 6.00 mils	Min hole diameter:	11.81 mils
Copper Finish:	None	Impedance Control:	No
Castellated pads:	No	Plated Board Edge:	No
Edge card connectors:	No		

